



Product Change Notification

Change Notification #: 117338 - 00
Change Title: Intel® Server Accessory AUP8X25S3DPDK,
Intel® Server Accessory AUP8X25S3NVDK,
PCN 117338-00, Product Design,
2.5" HDD Carrier Bottom Beam Structure
Improvement
Date of Publication: December 12, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	January 6, 2020
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is adding a hem to the bottom of the 2.5" HDD carrier of the Intel® Server Accessory AUP8X25S3DPDK and Intel® Server Accessory AUP8X25S3NVDK to improve structure integrity as shown in the following figure.

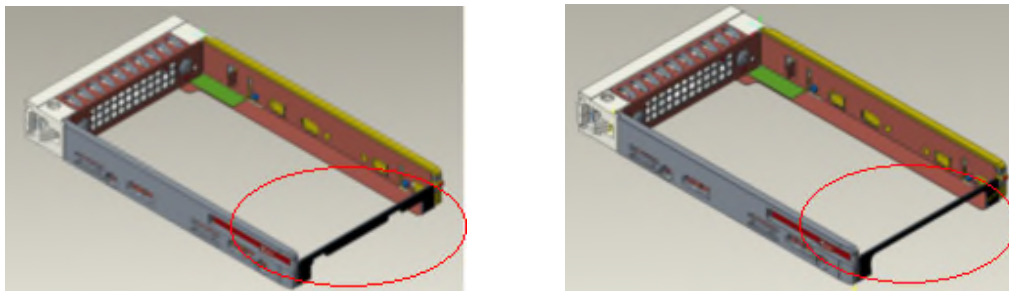


Figure. Current Design (left) Improved design (Right)

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
AUP8X25S3DPDK	953392	J32847-002	J32847-003
AUP8X25S3NVDK	953393	J21195-002	J21195-003

PCN Revision History:

Date of Revision:

December 12, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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